

## RELIABILITY MONITOR SAMPLING PLAN

<u>PRODUCT</u>	<u>FAMILY</u>	<u>TECHNOLOGY</u>	<u>ASSEMBLY</u>	<u>PACKAGE</u>	<u>QUANTITY</u>	<u>FREQUENCY</u>
1992	AUTO. ID.	Battery	Dallas	Touch Can	100	QUARTERLY
2401	AUTO. ID.	1.2 Ox Ni	Carsem	03 TO92	250	QUARTERLY
2502	AUTO. ID.	1.2 Ox Ni EPROM	Carsem	08 SOIC150	250	QUARTERLY
1210	BAT. BACK.	3.0 Ox Ni	Anam, K	16 SOIC	250	QUARTERLY
1232	CPU SUP.	3.0 Ox Ni	Hyundai	16 SOIC	250	QUARTERLY
1233	CPU SUP.	1.2 Ni	Carsem	03 SOT223	250	QUARTERLY
1000	DELAY	1.2 Ni	Omedata	08 PDIP	250	QUARTERLY
1267	DIG. POT.	1.2 Ox Ni	Hyundai	16 SOIC	250	QUARTERLY
1669	DIG. POT.	1.2 Ox Ni EEPROM	Omedata	08 SOIC200	250	QUARTERLY
1868	DIG. POT.	0.8 Ox Ni	Anam, K	20 TSSOP	250	QUARTERLY
232A	DRIVER	5.0 Ox Ni	Omedata	16 PDIP	250	QUARTERLY
5000T	MICRO	Battery	Dallas	40 Module	50	QUARTERLY
5002M	MICRO	1.2 Ox Ni	Anam, K / Carsem	80 PQFP	250	QUARTERLY/ALT
80C320	MICRO	0.8 Ox Ni	Anam, K	44 PLCC	250	QUARTERLY
1225	NV. MEMORY	Battery	Dallas	28 Module	210	QUARTERLY
1230	NV. MEMORY	Battery	Dallas	28 Module	210	QUARTERLY
2250 / 2290	SipStik	Battery	Dallas	PCB	33	QUARTERLY/ALT
2107A	TELECOM	1.2 Ni	Carsem	16 SOIC	250	QUARTERLY
21S07A	TELECOM	0.8 Ni	Anam, PI	20 TSSOP	250	QUARTERLY
2165 / 2175	TELECOM	1.2 Ox / 2.0 Ox	Hyundai / Anam, K	24 PDIP / 16 SOIC	250	QUARTERLY/ALT
2180A / 2181A	TELECOM	2.0 Ox	Anam, K	44 PLCC	250	QUARTERLY/ALT
1620	THERMAL MGR.	1.2 Ox Ni	Omedata	08 SOIC200	250	QUARTERLY
12885	TIME	1.2 Ox Ni	Anam, K / Hyundai	24 SOIC	250	QUARTERLY/ALT
12887	TIME	Battery	Dallas	24 Module	210	QUARTERLY
1302	TIME	0.8 Ox Ni (2 MTL)	Anam, K / Hyundai	08 SOIC150	250	QUARTERLY/ALT
1585	TIME	1.2 Ox Ni	Anam, PI	28 PDIP	250	QUARTERLY
1643	TIME	Battery	Dallas	28 Module	100	QUARTERLY

Table 1